Infineon Technologies - MB91F524KHBPMC1-GSE1 Datasheet

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	FR81S
Core Size	32-Bit Single-Core
Speed	80MHz
Connectivity	CANbus, CSIO, I²C, LINbus, SPI, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	120
Program Memory Size	576KB (576K x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	72K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 48x12b; D/A 2x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb91f524khbpmc1-gse1

Product lineup comparison 144 pins

	MB91F522K	MB91F523K	MB91F524K	MB91F525K	MB91F526K
System Clock	On chip PLL Clock multiple method				
Minimum instruction execution time	12.5ns (80MHz)				
Flash Capacity (Program)	(256+64)KB	(384+64)KB	(512+64)KB	(768+64)KB	(1024+64)KB
Flash Capacity (Data)	64KB				
RAM Capacity	(48+8)KB		(64+8)KB	(96+8)KB	(128+8)KB
External BUS I/F (22address/16data/4cs)	Yes				
DMA Transfer	16ch				
16-bit Base Timer	2ch				
Free-run Timer	16bit×3ch, 32bit×3ch				
Input capture	16bit×4ch, 32bit×6ch				
Output Compare	16bit×6ch, 32bit×6ch				
16-bit Reload Timer	8ch				
PPG	16bit×44ch				
Up/down Counter	2ch				
Clock Supervisor	Yes				
External Interrupt	8ch×2units				
A/D converter	12bit×32ch (1unit), 12bit×16ch (1unit)				
D/A converter (8bit)	2ch				
Multi-Function Serial Interface	12ch*1				
CAN	64msg×2ch/128msg×1ch				
Hardware Watchdog Timer	Yes				
CRC Formation	Yes				
Low-voltage detection reset	Yes				
Flash Security	Yes				
ECC Flash/WorkFlash	Yes				
ECC RAM	Yes				
Memory Protection Function (MPU)	Yes				
Floating point arithmetic (FPU)	Yes				
Real Time Clock (RTC)	Yes				
General-purpose port (#GPIOs)	120 ports				
SSCG	Yes				
Sub clock	Yes				
CR oscillator	Yes				
NMI request function	Yes				
OCD (On Chip Debug)	Yes				
TPU (Timing Protection Unit)	Yes				
Key code register	Yes				
Waveform generator	6ch				
Operation guaranteed temperature (T_A)	-40°C to +125°C				
Power supply	2.7V to 5.5V *2				
Package	LQS144, LQN144				

*1: Only channel 3 and channel 4 support the I^2C (fast mode/standard mode).
Only channel 5, channel 6, channel 7, channel 8, channel 10 and channel 11 support the I^2C (standard mode).

*2: The initial detection voltage of the external low voltage detection is 2.8V±8% (2.576V to 3.024V). This LVD setting and internal LVD cannot be used to reliably generate a reset before voltage dips below minimum guaranteed operation voltage, as these detection levels are below the minimum guaranteed MCU operation voltage. Below the minimum guaranteed MCU operation voltage, MCU operations are not guaranteed with the exception of LVD.

3. Pin Description

Pin no.						Pin Name	Polarity	I/O circuit types*8	Function*9
64	80	100	120	144	176				
-	-	-	-	2	2	P015	-	A	General-purpose I/O port
						D29	-		External bus data bit29 I/O (0)
						TRG0_0	-		PPG trigger 0 input (0)
-	-	-	-	3	3	P016	-	A	General-purpose I/O port
						D30	-		External bus data bit30 I/O (0)
						TRG1_0	-		PPG trigger 1 input (0)
-	-	-	-	-	4	P170	-	A	General-purpose I/O port
						PPG36_1	-		PPG ch.36 output (1)
-	-	-	-	4	5	P017	-	A	General-purpose I/O port
						D31	-		External bus data bit31 I/O (0)
						TRG2_0	-		PPG trigger 2 input (0)
-	-	-	-	-	6	P171	-	A	General-purpose I/O port
						PPG37_1	-		PPG ch.37 output (1)
2 *1	2 *1	2 *1	2 *1	5	7	P020	-	F	General-purpose I/O port
						ASX *2, *3, *4, *5	-		External bus/Address strobe output
						SIN3_1	-		Multi-function serial ch.3 serial data input (1)
						TRG3_0	-		PPG trigger 3 input (0)
						TIN0_2	-		Reload timer ch.0 event input (2)
						RTO5_1	-		Waveform generator ch.5 output pin (1)
-	-	-	3 *1	6	8	P021	-	A	General-purpose I/O port
						CS0X *5	-		External bus chip select 0 output
						SOT3_1	-		Multi-function serial ch.3 serial data output (1)
						TRG6_1	-		PPG trigger 6 input (1)
						TRG4_0	-		PPG trigger 4 input (0)
-	-	-	4 *1	7	9	P022	-	F	General-purpose I/O port
						CS1X *5	-		External bus chip select 1 output
						SCK3_1	-		Multi-function serial ch.3 clock I/O (1)
						TRG7_1	-		PPG trigger 7 input (1)
						TRG5_0	-		PPG trigger 5 input (0)
-	-	-	5 *1	8	10	P023	-	A	General-purpose I/O port
						RDX *5	-		External bus/Read strobe output
						SCS3_1	-		Serial chip select 3 output (1)
						PPG32_0	-		PPG ch.32 output (0)
						TIN0_0	-		Reload timer ch.0 event input (0)

Pin no.						Pin Name	Polarity	I/O circuit types*8	Function*9
64	80	100	120	144	176				
9 *1	11 *1	14 *1	17 *1	20	24	P035	-	I	General-purpose I/O port
						A07 *2, *3, *4, *5	-		External bus/Address bit7 output
						SIN8_0 *2, *3	-		Multi-function serial ch.8 serial data input (0)
						OCU8_1	-		Output compare ch.8 output (1)
						TOT4_0	-		Reload timer ch.4 output (0)
						AIN0_0	-		U/D counter ch.0 AIN input (0)
						INT11_0	-		INT11 External interrupt input (0)
10 *1	12 *1	15 *1	18 *1	21	25	P036	-	A	General-purpose I/O port
						A08 *2, *3, *4, *5	-		External bus/Address bit8 output (0)
						SCS8_0 *2, *3	-		Serial chip select 8 I/O (0)
						OCU7_1	-		Output compare ch.7 output (1)
						TOT5_0	-		Reload timer ch.5 output (0)
						BIN0_0	-		U/D counter ch.0 BIN input (0)
-	-	16 *1	19 *1	22	26	P037	-	A	General-purpose I/O port
						A09 *4, *5	-		External bus/Address bit9 output (0)
						OCU6_1	-		Output compare ch.6 output (1)
						TOT6_0	-		Reload timer ch.6 output (0)
						ZIN0_0	-		U/D counter ch.0 ZIN input (0)
-	-	-	-	-	27	P174	-	A	General-purpose I/O port
						TRG8_1	-		PPG trigger 8 input (1)
-	-	-	-	-	28	P175	-	A	General-purpose I/O port
						TRG9_1	-		PPG trigger 9 input (1)
11 *1	13 *1	17 *1	20 *1	23	29	P040	-	A	General-purpose I/O port
						A10 *2, *3, *4, *5	-		External bus/Address bit10 output (0)
						PPG23_1	-		PPG ch.23 output (1)
						TOT7_0	-		Reload timer ch.7 output (0)
						AIN1_0	-		U/D counter ch.1 AIN input (0)
						SIN0_1	-		Multi-function serial ch.0 serial data input (1)
12 *1	14 *1	18 *1	21 *1	24	30	P041	-	I	General-purpose I/O port
						A11 *2, *3, *4, *5	-		External bus/Address bit11 output (0)
						SIN9_0	-		Multi-function serial ch.9 serial data input (0)
						ICU9_1	-		Input capture ch.9 input (1)
						BIN1_0	-		U/D counter ch.1 BIN input (0)
						INT12_0	-		INT12 External interrupt input (0)

5. Handling Precautions

Any semiconductor devices have inherently a certain rate of failure. The possibility of failure is greatly affected by the conditions in which they are used (circuit conditions, environmental conditions, etc.). This page describes precautions that must be observed to minimize the chance of failure and to obtain higher reliability from your Cypress semiconductor devices.

1. Precautions for Product Design

This section describes precautions when designing electronic equipment using semiconductor devices.

■ Absolute Maximum Ratings

Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of certain established limits, called absolute maximum ratings. Do not exceed these ratings.

■ Recommended Operating Conditions

Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their sales representative beforehand.

■ Processing and Protection of Pins

These precautions must be followed when handling the pins which connect semiconductor devices to power supply and input/output functions.

(1) Preventing Over-Voltage and Over-Current Conditions

Exposure to voltage or current levels in excess of maximum ratings at any pin is likely to cause deterioration within the device, and in extreme cases leads to permanent damage of the device. Try to prevent such overvoltage or over-current conditions at the design stage.

(2) Protection of Output Pins

Shorting of output pins to supply pins or other output pins, or connection to large capacitance can cause large current flows. Such conditions if present for extended periods of time can damage the device.
Therefore, avoid this type of connection.

(3) Handling of Unused Input Pins

Unconnected input pins with very high impedance levels can adversely affect stability of operation. Such pins should be connected through an appropriate resistance to a power supply pin or ground pin.

■ Latch-up

Semiconductor devices are constructed by the formation of P-type and N-type areas on a substrate. When subjected to abnormally high voltages, internal parasitic PNPN junctions (called thyristor structures) may be formed, causing large current levels in excess of several hundred mA to flow continuously at the power supply pin. This condition is called latch-up.

CAUTION: The occurrence of latch-up not only causes loss of reliability in the semiconductor device, but can cause injury or damage from high heat, smoke or flame. To prevent this from happening, do the following:

(1) Be sure that voltages applied to pins do not exceed the absolute maximum ratings. This should include attention to abnormal noise, surge levels, etc.

(2) Be sure that abnormal current flows do not occur during the power-on sequence.

■ Observance of Safety Regulations and Standards

Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

■ Fail-Safe Design

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

■ Precautions Related to Usage of Devices

Cypress semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION: Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

2. Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mount type. In either case, for heat resistance during soldering, you should only mount under Cypress's recommended conditions. For detailed information about mount conditions, contact your sales representative.

■ Lead Insertion Type

Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.

Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder. In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Cypress recommended mounting conditions.

If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

■ Surface Mount Type

Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges.

You must use appropriate mounting techniques. Cypress recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Cypress ranking of recommended conditions.

■ Lead-Free Packaging

CAUTION: When ball grid array (BGA) packages with Sn-Ag-Cu balls are mounted using Sn-Pb eutectic soldering, junction strength may be reduced under some conditions of use.

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
00125C$_H$	OCCPB4/OCCP4 [R/W] H,W 00000000 00000000		OCCPB5/OCCP5 [R/W] H,W 00000000 00000000		16-bit Output compare 4/5
001260$_H$	OCS45 [R/W] B,H,W -110--00 00001100		—	OCMOD45 [R/W] B,H,W ------00	
001264$_H$ to 001278$_H$	—	—	—	—	Reserved
00127C$_H$	IPCP0 [R] H,W 00000000 00000000		IPCP1 [R] H,W 00000000 00000000		16-bit Input capture 0/1
001280$_H$	ICS01 [R/W] B,H,W ------00 00000000		—	LSYNS [R/W] B,H,W ----0000	
001284$_H$	IPCP2 [R] H,W 00000000 00000000		IPCP3 [R] H,W 00000000 00000000		16-bit Input capture 2/3
001288$_H$	ICS23 [R/W] B,H,W ------00 00000000		—	—	
00128C$_H$ to 001298$_H$	—	—	—	—	Reserved
00129C$_H$	—	—	—	—	Reserved
0012A0$_H$	TMRR0 [R/W] H,W 00000000 00000001		TMRR1 [R/W] H,W 00000000 00000001		Waveform generator 0/1/2
0012A4$_H$	TMRR2 [R/W] H,W 00000000 00000001		—	—	
0012A8$_H$	DTSCR0 [R/W] B,H,W 00000000	DTSCR1 [R/W] B,H,W 00000000	DTSCR2 [R/W] B,H,W 00000000	—	
0012AC$_H$	—	DTIR0 [R/W] B,H,W 000000--	—	DTMNS0 [R/W] B,H,W 00---000	
0012B0$_H$	—	SIGCR10 [R/W] B,H,W 00000000	—	SIGCR20 [R/W] B,H,W 000000-1	
0012B4$_H$	PICS0 [R/W] B,H,W 000000-- -------- -------- --------				
0012B8$_H$ to 0012CC$_H$	—	—	—	—	Reserved
0012D0$_H$	FRS5 [R/W] B,H,W --00--00 --00--00 --00--00 --00--00				16-bit Free-run timer selection A/D activation compare

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
00147C$_H$	ADCOMP34/ADCOMPB34[R/W] H,W 00000000 00000000		ADCOMP35/ADCOMPB35[R/W] H,W 00000000 00000000		12-bit A/D converter 2/2 unit
001480$_H$	ADCOMP36/ADCOMPB36[R/W] H,W 00000000 00000000		ADCOMP37/ADCOMPB37[R/W] H,W 00000000 00000000		
001484$_H$	ADCOMP38/ADCOMPB38[R/W] H,W 00000000 00000000		ADCOMP39/ADCOMPB39[R/W] H,W 00000000 00000000		
001488$_H$	ADCOMP40/ADCOMPB40[R/W] H,W 00000000 00000000		ADCOMP41/ADCOMPB41[R/W] H,W 00000000 00000000		
00148C$_H$	ADCOMP42/ADCOMPB42[R/W] H,W 00000000 00000000		ADCOMP43/ADCOMPB43[R/W] H,W 00000000 00000000		
001490$_H$	ADCOMP44/ADCOMPB44[R/W] H,W 00000000 00000000		ADCOMP45/ADCOMPB45[R/W] H,W 00000000 00000000		
001494$_H$	ADCOMP46/ADCOMPB46[R/W] H,W 00000000 00000000		ADCOMP47/ADCOMPB47[R/W] H,W 00000000 00000000		
001498$_H$ to 0014B4$_H$	—	—	—	—	Reserved
0014B8$_H$	ADTCS32[R/W] B,H,W 00000000 0010----		ADTCS33[R/W] B,H,W 00000000 0010----		12-bit A/D converter 2/2 unit
0014BC$_H$	ADTCS34[R/W] B,H,W 00000000 0010----		ADTCS35[R/W] B,H,W 00000000 0010----		
0014C0$_H$	ADTCS36[R/W] B,H,W 00000000 0010----		ADTCS37[R/W] B,H,W 00000000 0010----		
0014C4$_H$	ADTCS38[R/W] B,H,W 00000000 0010----		ADTCS39[R/W] B,H,W 00000000 0010----		
0014C8$_H$	ADTCS40[R/W] B,H,W 00000000 0010----		ADTCS41[R/W] B,H,W 00000000 0010----		
0014CC$_H$	ADTCS42[R/W] B,H,W 00000000 0010----		ADTCS43[R/W] B,H,W 00000000 0010----		
0014D0$_H$	ADTCS44[R/W] B,H,W 00000000 0010----		ADTCS45[R/W] B,H,W 00000000 0010----		
0014D4$_H$	ADTCS46[R/W] B,H,W 00000000 0010----		ADTCS47[R/W] B,H,W 00000000 0010----		
0014D8$_H$ to 0014F4$_H$	—	—	—	—	Reserved
0014F8$_H$	ADTCD32[R] B,H,W 10--0000 00000000		ADTCD33[R] B,H,W 10--0000 00000000		12-bit A/D converter 2/2 unit
0014FC$_H$	ADTCD34[R] B,H,W 10--0000 00000000		ADTCD35[R] B,H,W 10--0000 00000000		

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
001928_H	FCR111[R/W] B,H,W ---00100	FCR011[R/W] B,H,W -0000000	FBYTE11[R/W] B,H,W 00000000 00000000		Multi-UART11
$00192C_H$	FTICR11[R/W] B,H,W 00000000 00000000		—	—	
001930_H to $0019D8_H$	—	—	—	—	Reserved
$0019DC_H$	—	GATEC0 [R/W] B,H,W ------00	—	GATEC2 [R/W] B,H,W ------00	PPG GATE control
$0019E0_H$	—	GATEC4 [R/W] B,H,W ------00	—	—	
$0019E4_H$	—	—	—	—	Reserved
$0019E8_H$	GTRS0 [R/W] B,H,W -0000000 -0000000		GTRS1 [R/W] B,H,W -0000000 -0000000		PPG controller
$0019EC_H$	GTRS2 [R/W] B,H,W -0000000 -0000000		GTRS3 [R/W] B,H,W -0000000 -0000000		
$0019F0_H$	GTRS4 [R/W] B,H,W -0000000 -0000000		GTRS5 [R/W] B,H,W -0000000 -0000000		
$0019F4_H$	GTRS6 [R/W] B,H,W -0000000 -0000000		GTRS7 [R/W] B,H,W -0000000 -0000000		
$0019F8_H$	GTRS8 [R/W] B,H,W -0000000 -0000000		GTRS9 [R/W] B,H,W -0000000 -0000000		PPG controller
$0019FC_H$	GTRS10 [R/W] B,H,W -0000000 -0000000		GTRS11 [R/W] B,H,W -0000000 -0000000		
$001A00_H$	GTRS12 [R/W] B,H,W -0000000 -0000000		GTRS13 [R/W] B,H,W -0000000 -0000000		
$001A04_H$	GTRS14 [R/W] B,H,W -0000000 -0000000		GTRS15 [R/W] B,H,W -0000000 -0000000		
$001A08_H$	GTRS16 [R/W] B,H,W -0000000 -0000000		GTRS17 [R/W] B,H,W -0000000 -0000000		
$001A0C_H$	GTRS18 [R/W] B,H,W -0000000 -0000000		GTRS19 [R/W] B,H,W -0000000 -0000000		
$001A10_H$	GTRS20 [R/W] B,H,W -0000000 -0000000		GTRS21 [R/W] B,H,W -0000000 -0000000		
$001A14_H$	GTRS22 [R/W] B,H,W -0000000 -0000000		GTRS23 [R/W] B,H,W -0000000 -0000000		
$001A18_H$ to $001A2C_H$	—	—	—	—	Reserved

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
0021C0$_H$ to 0021FC$_H$	—				CAN1 (64msb)
002200$_H$	CTRLR2 [R/W] B,H,W -------- 000-0001		STATR2 [R/W] B,H,W -------- 00000000		CAN2 (64msb)
002204$_H$	ERRCNT2 [R] B,H,W 00000000 00000000		BTR2 [R/W] B,H,W -0100011 00000001		
002208$_H$	INTR2 [R] B,H,W 00000000 00000000		TESTR2 [R/W] B,H,W -------- X00000--		
00220C$_H$	BRPER2 [R/W] B,H,W -------- ----0000		—		
002210$_H$	IF1CREQ2 [R/W] B,H,W 0------- 00000001		IF1CMSK2 [R/W] B,H,W -------- 00000000		
002214$_H$	IF1MSK22 [R/W] B,H,W 11-11111 11111111		IF1MSK12 [R/W] B,H,W 11111111 11111111		
002218$_H$	IF1ARB22 [R/W] B,H,W 00000000 00000000		IF1ARB12 [R/W] B,H,W 00000000 00000000		
00221C$_H$	IF1MCTR2 [R/W] B,H,W 00000000 0---0000		—		
002220$_H$	IF1DTA12 [R/W] B,H,W 00000000 00000000		IF1DTA22 [R/W] B,H,W 00000000 00000000		
002224$_H$	IF1DTB12 [R/W] B,H,W 00000000 00000000		IF1DTB22 [R/W] B,H,W 00000000 00000000		
002228$_H$	—	—	—	—	
00222C$_H$	—	—	—	—	
002230$_H$, 002234$_H$	Reserved (IF1 data mirror)				
002238$_H$	—	—	—	—	
00223C$_H$	—	—	—	—	
002240$_H$	IF2CREQ2 [R/W] B,H,W 0------- 00000001		IF2CMSK2 [R/W] B,H,W -------- 00000000		
002244$_H$	IF2MSK22 [R/W] B,H,W 11-11111 11111111		IF2MSK12 [R/W] B,H,W 11111111 11111111		
002248$_H$	IF2ARB22 [R/W] B,H,W 00000000 00000000		IF2ARB12 [R/W] B,H,W 00000000 00000000		CAN2 (64msb)
00224C$_H$	IF2MCTR2 [R/W] B,H,W 00000000 0---0000		—		
002250$_H$	IF2DTA12 [R/W] B,H,W 00000000 00000000		IF2DTA22 [R/W] B,H,W 00000000 00000000		

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
003030_H	TEAR0A[R] B,H,W 000----- -------- -----000 00000000				RAM/ diagnosis Backup RAM
003034_H	TEAR1A[R] B,H,W 000----- -------- -----000 00000000				
003038_H	TEAR2A[R] B,H,W 000----- -------- -----000 00000000				
$00303C_H$	TAEARA[R/W] B,H,W -----111 11111111		TASARA[R/W] B,H,W -----000 00000000		
003040_H	TFECRA [R/W] B,H,W ----0000	TICRA [R/W] B,H,W ----0000	TTCRA [R/W] B,H,W ------00 00001100		RAM/ diagnosis Backup RAM
003044_H	TSRCRA [R/W] B,H,W 0-------	—	—	TKCCRA [R/W] B,H,W 00----00	
003048_H to $0030FC_H$	—				Reserved
003100_H	BUSDIGSR0[R/W] H,W 00000000 0-----00		BUSDIGSR1[R/W] H,W 00000000 0-----00		BUS diagnosis
003104_H	BUSDIGSR2[R/W] H,W 00000000 0-----00		BUSTSTR0[R/W] H,W 00--0000 00000000		
003108_H	BUSADR0 [R] W 00000000 00000000 00000000 00000000				
$00310C_H$	BUSADR1 [R] W 00000000 00000000 00000000 00000000				
003110_H	BUSADR2 [R] W 00000000 00000000 00000000 00000000				
003114_H	—	—	BUSDIGSR3[R/W] H,W 00000000 0-----00		
003118_H	BUSDIGSR4[R/W] H,W 00000000 0-----00		BUSTSTR1[R/W] H,W 00--000- 00000000		
$00311C_H$	—	—	—	—	
003120_H	BUSADR3 [R] W 00000000 00000000 00000000 00000000				
003124_H	BUSADR4 [R] W 00000000 00000000 00000000 00000000				
003128_H to $003FFC_H$	—				Reserved
004000_H to $005FFC_H$	Backup-RAM				Backup RAM area

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN
	Decimal	Hexa decimal				
Clock calibration unit (sub oscillation) Multi-function serial interface ch.9 (reception completed) Multi-function serial interface ch.9 (status)	47	2F	ICR31	340_H	$000FFF40_H$	31*1,*4
A/D converter 0/1/7/10/11/14/15/16/17/22/27/28/31	48	30	ICR32	$33C_H$	$000FFF3C_H$	32
Clock calibration unit (CR oscillation) Multi-function serial interface ch.9 (transmission completed) 16-bit OCU 0 (match) / 16-bit OCU 1 (match)	49	31	ICR33	338_H	$000FFF38_H$	33
32-bit Free-run timer 4 16-bit OCU 2 (match) / 16-bit OCU 3 (match)	50	32	ICR34	334_H	$000FFF34_H$	34*5
16-bit OCU 4 (match) / 16-bit OCU 5 (match)	51	33	ICR35	330_H	$000FFF30_H$	35
32-bit ICU6 (fetching/measurement) Multi-function serial interface ch.10 (reception completed) Multi-function serial interface ch.10 (status)	52	34	ICR36	$32C_H$	$000FFF2C_H$	36*1
Multi-function serial interface ch.10 (transmission completed)	53	35	ICR37	328_H	$000FFF28_H$	37
32-bit ICU8 (fetching/measurement) Multi-function serial interface ch.11 (reception completed) Multi-function serial interface ch.11 (status)	54	36	ICR38	324_H	$000FFF24_H$	38*1
32-bit ICU9 (fetching/measurement) WG dead timer underflow 0 / 1/ 2 WG dead timer reload 0 / 1/ 2 WG DTTI 0	55	37	ICR39	320_H	$000FFF20_H$	39
32-bit ICU4 (fetching/measurement) Multi-function serial interface ch.11 (transmission completed)	56	38	ICR40	$31C_H$	$000FFF1C_H$	40
32-bit ICU5 (fetching/measurement) A/D converter 32/34/35/37/38/40/41/42/43/44/45/46/47	57	39	ICR41	318_H	$000FFF18_H$	41
32-bit OCU7/11 (match)	58	3A	ICR42	314_H	$000FFF14_H$	42
32-bit OCU8/9 (match)	59	3B	ICR43	310_H	$000FFF10_H$	43
-	60	3C	ICR44	$30C_H$	$000FFF0C_H$	-*6
- -	61	3D	ICR45	308_H	$000FFF08_H$	-
DMAC0/1/2/3/4/5/6/7/8/9/10/11/12/13/14/15	62	3E	ICR46	304_H	$000FFF04_H$	-
Delay interrupt	63	3F	ICR47	300_H	$000FFF00_H$	-
System reserved (Used for REALOS™*8)	64	40	-	$2FC_H$	$000FFEFC_H$	-
System reserved (Used for REALOS)	65	41	-	$2F8_H$	$000FFEF8_H$	-

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN
	Decimal	Hexa decimal				
Used with the INT instruction	66 | 255	42 | FF	-	$2F4_H$ | 000_H	$000FFEF4_H$ | $000FFC00_H$	-

Note: It does not support a DMA transfer request caused by an interrupt generated from a peripheral to which no RN (Resource Number) is assigned.

*1: It does not support a DMA transfer by the status of the multi-function serial interface and I^2C reception.

*2: Reload timer ch.4 to ch.7 do not support a DMA transfer by the interrupt.

*3: PPG ch.24 to ch.47 do not support a DMA transfer by the interrupt.

*4: The clock calibration unit does not support a DMA transfer by the interrupt.

*5: 32-bit Free-run timer ch.3, ch.4 and ch.5 do not support a DMA transfer by the interrupt.

*6: There is no resource corresponding to the interrupt level.

*7: It does not support a DMA transfer by the external low-voltage detection interrupt.

*8: REALOS is a trademark of Cypress.

100 pins

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN
	Decimal	Hexadecimal				
Reset	0	0	-	$3FC_H$	$000FFFFC_H$	-
System reserved	1	1	-	$3F8_H$	$000FFFF8_H$	-
System reserved	2	2	-	$3F4_H$	$000FFFF4_H$	-
System reserved	3	3	-	$3F0_H$	$000FFFF0_H$	-
System reserved	4	4	-	$3EC_H$	$000FFFEC_H$	-
FPU exception	5	5	-	$3E8_H$	$000FFFE8_H$	-
Exception of instruction access protection violation	6	6	-	$3E4_H$	$000FFFE4_H$	-
Exception of data access protection violation	7	7	-	$3E0_H$	$000FFFE0_H$	-
Data access error interrupt	8	8	-	$3DC_H$	$000FFFDC_H$	-
INTE instruction	9	9	-	$3D8_H$	$000FFFD8_H$	-
Instruction break	10	0A	-	$3D4_H$	$000FFFD4_H$	-
System reserved	11	0B	-	$3D0_H$	$000FFFD0_H$	-
System reserved	12	0C	-	$3CC_H$	$000FFFCC_H$	-
System reserved	13	0D	-	$3C8_H$	$000FFFC8_H$	-
Exception of invalid instruction	14	0E	-	$3C4_H$	$000FFFC4_H$	-
NMI request Error generation during internal bus diagnosis XBS RAM double-bit error generation Backup RAM double-bit error generation TPU violation	15	0F	15 (F_H) Fixed	$3C0_H$	$000FFFC0_H$	-
External interrupt 0-7	16	10	ICR00	$3BC_H$	$000FFFBC_H$	0
External interrupt 8-15 External low-voltage detection interrupt	17	11	ICR01	$3B8_H$	$000FFFB8_H$	1*7
Reload timer 0/1/4/5	18	12	ICR02	$3B4_H$	$000FFFB4_H$	2*2
Reload timer 2/3/6/7	19	13	ICR03	$3B0_H$	$000FFFB0_H$	3*2
Multi-function serial interface ch.0 (reception completed) Multi-function serial interface ch.0 (status)	20	14	ICR04	$3AC_H$	$000FFFAC_H$	4*1
Multi-function serial interface ch.0 (transmission completed)	21	15	ICR05	$3A8_H$	$000FFFA8_H$	5*1
Multi-function serial interface ch.1 (reception completed) Multi-function serial interface ch.1 (status)	22	16	ICR06	$3A4_H$	$000FFFA4_H$	6*1
Multi-function serial interface ch.1 (transmission completed)	23	17	ICR07	$3A0_H$	$000FFFA0_H$	7*1
Multi-function serial interface ch.2 (reception completed) Multi-function serial interface ch.2 (status)	24	18	ICR08	$39C_H$	$000FFF9C_H$	8*1
Multi-function serial interface ch.2 (transmission completed)	25	19	ICR09	398_H	$000FFF98_H$	9*1
Multi-function serial interface ch.3 (reception completed) Multi-function serial interface ch.3 (status)	26	1A	ICR10	394_H	$000FFF94_H$	10*1

11. Electrical Characteristics

Absolute Maximum Ratings

Parameter		Symbol	Rating		Unit	Remarks
			Min	Max		
Power supply voltage *1,*2		V_{CC}	V_{SS}-0.3	V_{SS}+6.0	V	
Analog power supply voltage *1,*2		AV_{CC}	V_{SS}-0.3	V_{SS}+6.0	V	AVRH ≤ AV_{CC} ≤ V_{CC}
Analog reference voltage *1		AVRH	V_{SS}-0.3	V_{SS}+6.0	V	AVRH ≤ AV_{CC}
Input voltage *1		V_I	V_{SS}-0.3	V_{CC}+0.3	V	
Analog pin input voltage *1		V_{IA5}	V_{SS}-0.3	V_{CC}+0.3	V	
Output voltage *1		V_o	V_{SS}-0.3	V_{CC}+0.3	V	
Maximum clamp current		I_{CLAMP}	-	4.0	mA	*6
Total maximum clamp current		$\Sigma\|I_{CLAMP}\|$	-	20	mA	*6
"L" level maximum output current *3		I_{OL1}	-	15	mA	
		I_{OL2}	-	30	mA	
"L" level average output current *4		I_{OLAV1}	-	4	mA	*9
		I_{OLAV2}	-	12	mA	*10
"L" level total output current *5		ΣI_{OL1}	-	100	mA	
		ΣI_{OL2}	-	120	mA	
"H" level maximum output current*3		I_{OH1}	-	-15	mA	
		I_{OH2}	-	-30	mA	
"H" level average output current*4		I_{OHAV1}	-	-4	mA	*9
		I_{OHAV2}	-	-12	mA	*10
"H" level total output current *5		ΣI_{OH1}	-	-100	mA	
		ΣI_{OH2}	-	-120	mA	
Power consumption	T_A: -40°C to +105°C	P_D	-	882	mW	*8
	T_A: -40°C to +125°C		-	675	mW	*8
Operating temperature		T_A	-40	+105	°C	
			-40	+125	°C	*7
Storage temperature		Tstg	-55	+150	°C	

*1: These parameters are based on the condition that V_{SS}=AV_{SS}=0.0V

*2: Caution must be taken that AV_{CC}, AVRH do not exceed V_{CC} upon power-on and under other circumstances.

*3: The maximum output current is defined as the value of the peak current flowing through any one of the corresponding pins.

*4: The average output current is defined as the value of the average current flowing through any one of the corresponding pins for a 10 ms period. The average value is the operation current × the operation ratio.

*5: The total output current is defined as the maximum current value flowing through all of corresponding pins.

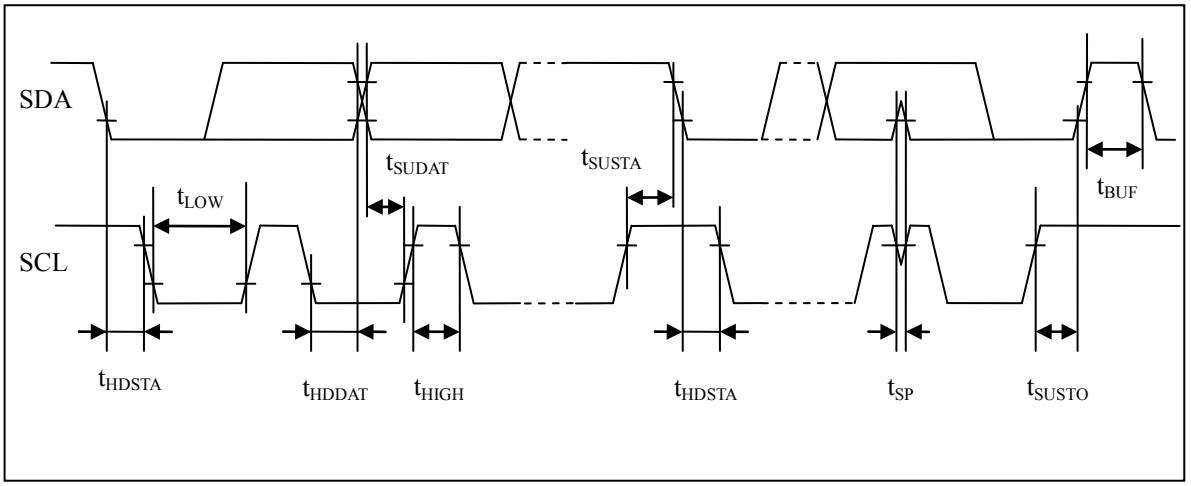
*6:
- Corresponding pins: all general-purpose ports except P035, 041, 093, 122.
- Use within recommended operating conditions.
- Use at DC voltage (current).
- The + B signal should always be applied by connecting a limiting resistor between the + B signal and the microcontroller.
- The value of the limiting resistor should be set so that the current input to the microcontroller pin does not exceed rated values at any time regardless of instantaneously or constantly when the + B signal is input.
- Note that when the microcontroller drive current is low, such as in the low power consumption modes, the + B input potential can increase the potential at the V_{CC} pin via a protective diode, possibly affecting other devices.
- Note that if the + B signal is input when the microcontroller is off (not fixed at 0 V), since the power is supplied through the pin, the microcontroller may operate incompletely.
- Note that if the +B signal is input at power-on, since the power is supplied through the pin, the power-on reset may not function in the power supply voltage.
- Do not leave + B input pins open.

*7: When it is used under this condition, contact your sales representative.

"t_{SUDAT} ≥ 250 ns".

*4: t_{CPP} is the peripheral clock cycle time. Adjust the clock of the bus in the surrounding to 8MHz or more when use I^2C.

・ I^2C timing



Parameter	Symbol	Pin name	Value		Unit	Remarks
			Min	Max		
WRnX delay time	t_{CHWL}, t_{CHWH}	SYSCLK WR0X, WR1X	0.5	18	ns	
WRnX minimum pulse	t_{WLWH}	WR0X, WR1X	t_{CYC} - 10	-	ns	WWT=0 *2
SYSCLK↑→ data output time	t_{CHDV}	SYSCLK D16 to D31	0.5	18	ns	
SYSCLK↑→ data hold time	t_{CHDX}		-	18	ns	Set WRCS to 1 or more.
SYSCLK↑→ address output time	t_{CHMAV}	SYSCLK D16 to D31	0.5	18	ns	
SYSCLK↑→ address hold time	t_{CHMAX}		-	18	ns	In multiplex mode, set as follows: □Set CSWR and CSRD to 2 or more. □ASCY must satisfy the following conditions because of setting ADCY > ASCY and protocol violation prevention. ADCY +1 ≤ ACS + CSRD ADCY +1 ≤ ACS + CSWR ASCY + 1 ≤ ACS + CSRD ASCY + 1 ≤ ACS + CSWR See Hardware Manual for details.

*1: Please use it with external load capacity 12pF or less for VCC=3.3V±0.3V (40MHz operation).

*2: If the bus is expanded by automatic wait insertion or RDY input, add time (t_{CYC} × the number of expanded cycles) to the rated value.

Part number	Sub clock	CSV Initial value	LVD Initial value	Package*2
MB91F526KWBPMC1	Yes	ON	ON	LQN・144 pin, (Lead pitch 0.4mm) Plastic
MB91F526KYBPMC1			OFF	
MB91F526KJBPMC1		OFF	ON	
MB91F526KLBPMC1			OFF	
MB91F525KWBPMC1		ON	ON	
MB91F525KYBPMC1			OFF	
MB91F525KJBPMC1		OFF	ON	
MB91F525KLBPMC1			OFF	
MB91F524KWBPMC1		ON	ON	
MB91F524KYBPMC1			OFF	
MB91F524KJBPMC1		OFF	ON	
MB91F524KLBPMC1			OFF	
MB91F523KWBPMC1		ON	ON	
MB91F523KYBPMC1			OFF	
MB91F523KJBPMC1		OFF	ON	
MB91F523KLBPMC1			OFF	
MB91F522KWBPMC1		ON	ON	
MB91F522KYBPMC1			OFF	
MB91F522KJBPMC1		OFF	ON	
MB91F522KLBPMC1			OFF	
MB91F526KSBPMC1	None	ON	ON	
MB91F526KUBPMC1			OFF	
MB91F526KHBPMC1		OFF	ON	
MB91F526KKBPMC1			OFF	
MB91F525KSBPMC1		ON	ON	
MB91F525KUBPMC1			OFF	
MB91F525KHBPMC1		OFF	ON	
MB91F525KKBPMC1			OFF	
MB91F524KSBPMC1		ON	ON	
MB91F524KUBPMC1			OFF	
MB91F524KHBPMC1		OFF	ON	
MB91F524KKBPMC1			OFF	
MB91F523KSBPMC1		ON	ON	
MB91F523KUBPMC1			OFF	
MB91F523KHBPMC1		OFF	ON	
MB91F523KKBPMC1			OFF	
MB91F522KSBPMC1		ON	ON	
MB91F522KUBPMC1			OFF	
MB91F522KHBPMC1		OFF	ON	
MB91F522KKBPMC1			OFF	

Part number	Sub clock	CSV Initial value	LVD Initial value	Package*
MB91F526BWEPMC1	Yes	ON	ON	LQE・64 pin, Plastic
MB91F526BJEPMC1		OFF	ON	
MB91F525BWEPMC1		ON	ON	
MB91F525BJEPMC1		OFF	ON	
MB91F524BWEPMC1		ON	ON	
MB91F524BJEPMC1		OFF	ON	
MB91F523BWEPMC1		ON	ON	
MB91F523BJEPMC1		OFF	ON	
MB91F522BWEPMC1		ON	ON	
MB91F522BJEPMC1		OFF	ON	
MB91F526BSEPMC1	None	ON	ON	
MB91F526BHEPMC1		OFF	ON	
MB91F525BSEPMC1		ON	ON	
MB91F525BHEPMC1		OFF	ON	
MB91F524BSEPMC1		ON	ON	
MB91F524BHEPMC1		OFF	ON	
MB91F523BSEPMC1		ON	ON	
MB91F523BHEPMC1		OFF	ON	
MB91F522BSEPMC1		ON	ON	
MB91F522BHEPMC1		OFF	ON	

*: For details of the package, see "■ PACKAGE DIMENSIONS ".

19. Major Changes

Spansion Publication Number: MB91F526L_DS705-00011

Page	Section	Change Results
Revision 1.0		
-	-	Initial release
Revision 2.0		
3	■FEATURES	Corrected the following description. 5V tolerant input: 4 channels ch.6, ch.8, ch.9, ch.11 Automotive input ↓ 5V tolerant input: 4 channels ch.6, ch.8, ch.9, ch.11 CMOS hysteresis input
33 to 36	■I/O CIRCUIT TYPE	Corrected the following description to "Type F, G, I, J, K, M". Schmitt input → CMOS hysteresis input Corrected the following description to "Type D, E". I^2C Schmitt input → I^2C hysteresis input
44 to 49	■BLOCK DIAGRAM	Corrected the following description. ●MB91F522B, MB91F523B, MB91F524B, MB91F525B, MB91F526B ●MB91F522D, MB91F523D, MB91F524D, MB91F525D, MB91F526D ●MB91F522F, MB91F523F, MB91F524F, MB91F525F, MB91F526F ●MB91F522J, MB91F523J, MB91F524J, MB91F525J, MB91F526J ●MB91F522K, MB91F523K, MB91F524K, MB91F525K, MB91F526K ●MB91F522L, MB91F523L, MB91F524L, MB91F525L, MB91F526L
138	■ELECTRICAL CHARACTERISTICS 2. Recommended operating conditions	Added the following description. *1 : When it is used outside recommended operation guarantee range (range of the operation guarantee),contact your sales representative. Moreover, minimum value with an effective external low-voltage detection reset becomes a voltage until generating low-voltage detection reset
139,140	■ELECTRICAL CHARACTERISTICS 3.DC characteristics	Corrected the value of "ICCT5 When using sub clock 32kHz TA=+25°C ". Max 1420μA → Max 2000μA
139	■ELECTRICAL CHARACTERISTICS 3.DC characteristics	Corrected the value of "Power supply voltage range". (TA:-40°C to +105°C,Vcc=AVcc=2.7V to 5.5V,VSS=AVSS=0.0V) ↓ (T_A:-40°C to +105°C,Vcc=AVcc=5.0V±10%/3.3V±0.3V,V_{SS}=AV_{SS}=0.0V)
140,141	■ELECTRICAL CHARACTERISTICS 3.DC characteristics	Corrected the value of "Power supply voltage range". (T_A:-40°C to +125°C,Vcc=AVcc=2.7V to 5.5V,VSS=AVSS=0.0V) ↓ (T_A:-40°C to +125°C,Vcc=AVcc=5.0V±10%/3.3V±0.3V,V_{SS}=AV_{SS}=0.0V)
141	■ELECTRICAL CHARACTERISTICS 3.DC characteristics	Corrected the value of " Pull-up resistance R_{UP1}". Vcc=3.3V±0.3V Min 49 Max 140 →Min 45 Max 140

Page	Section	Change Results
143	■Electrical Characteristics 1. Absolute Maximum Ratings	The following note added. (Correct) *9: Corresponding pins: General-purpose ports other than those of P103, P104, P105 and P106. *10: Corresponding pins: General-purpose ports of P103, P104, P105 and P106.
155	■Electrical Characteristics AC Characteristics (2) Reset Input	Added the At power-on*2 condition to the remarks in Reset input time.
156	■Electrical Characteristics AC Characteristics (3) Power-on Conditions	Deleted the Slope detection undetected specification. Added the Power ramp rate and C pin voltage at Power-on. *1, *2: Changed the sentence. Added *3, *4, Note, Figure at the Power off time, Power ramp rate, C pin voltage at Power-on.
6 to 11, 203 to 216	■Product lineup ■Ordering information	Package description modified to JEDEC description.
47	■During Power-on	The following sentence modified as fdeleted from Interrupt (Error) To prevent a malfunction of the voltage step-down circuit built in the device, set the voltage rising time to have 50µs or longer (between 0.2V and 2.7V) during power-on. (Correct) To prevent a malfunction of the voltage step-down circuit built in the device, the voltage rising must be monotonic increasing during power-on. Power-on prohibits that the voltage goes up and down and voltage rising stops temporarily.
49, 50	■Block Diagram	The following Block diagram modified as follows: ●MB91F522B, MB91F523B, MB91F524B, MB91F525B, MB91F526B ●MB91F522D, MB91F523D, MB91F524D, MB91F525D, MB91F526D (Error) CAN (2ch). (Correct) CAN (3ch)
217 to 220	■Ordering Information	Added the following description. ■ORDERING INFORMATION MB91F52xxxD
221 to 227	■Package Dimensions	Package Dimensions modified to JEDEC description.